

RADIATION CONVERTING SUBSTRATE, RADIATION IMAGE
PICKUP APPARATUS AND RADIATION IMAGE PICKUP SYSTEM

BACKGROUND OF THE INVENTION

5 Field of the Invention

The present invention relates to a radiation
converting substrate, a radiation image pickup
apparatus and a radiation image pickup system, and
more particularly to a radiation converting substrate,
10 a radiation image pickup apparatus and a radiation
image pickup system including a phosphor layer for
converting a radiation into light and a moisture-
preventing protective layer.

Related Background Art

15 In the X-ray diagnosis for transmissive
inspection of a human body with X-ray, in place for a
conventional X-ray photographic method by a
sensitizing screen-film system based on a combination
of a sensitizing screen and a film, there has been
20 developed and commercialized a digital X-ray image
pickup apparatus based on digital radiography, which
is a novel radiation image pickup method utilizing a
phosphor and a photoelectric converting member. As a
radiation-light converting material to be employed in
25 the digital radiography, there is known a phosphor
utilizing an alkali halide. Methods for forming a
phosphor on the surface of a photoelectric converting

device can be principally classified into following two categories:

(1) a method of directly forming a phosphor by solvent coating or vacuum evaporation, either
5 directly or across a protective layer, on a surface of the photoelectric converting device; and

(2) a method of adhering a panel of phosphor with an adhesive material, either directly or across a protective layer, on a surface of the photoelectric
10 converting device.

Such phosphor based on alkali halide is known to be associated with a drawback that alkali halide in a prolonged storage or a prolonged use causes deliquescence by moisture in the air, thereby
15 resulting in a loss in the resolution of the X-ray image.

In the method (1), for example WO98/36290 discloses, in order to prevent deliquescence of the phosphor material, to cover the phosphor material
20 formed on the surface or the photoelectric converting device or the entire surface of a panel of the photoelectric converting device and the phosphor material with a moisture-preventing protective layer. As a material for the moisture-preventing protective
25 layer, there are disclosed polyparaxylilene, a metallic material and a silicone potting material. On the other hand, Japanese Patent Application Laid-

open No. 05-196742 discloses to form a thin film layer between a moisture-preventing barrier layer and a phosphor (scintillator). The thin film layer is provided for improving an adhesion between the
5 moisture-preventing barrier layer and the phosphor (scintillator). As a material for the thin film layer, there are disclosed organic materials such as polyparaxylilene, and organopolysiloxane-polycarbonate.

10 In the method (2), for example Japanese Patent Application Laid-open No. 2000-356679 discloses, in order to prevent deliquescence of the phosphor material, an invention of covering an entire surface of the phosphor panel with a moisture-preventing
15 protective layer. As a material for the moisture-preventing protective layer, there is disclosed a transparent film such as of paraxylilene.

Patent reference 1: W098/36290;

Patent reference 2: Japanese Patent Application
20 Laid-open No. 05-196742;

Patent reference 3: Japanese Patent Application Laid-open No. 2000-356679.

A digital X-ray image pickup apparatus formed with the aforementioned method (1) by directly
25 forming a phosphor by solvent coating or vacuum evaporation, either directly or across a protective layer, on the surface of the photoelectric converting

device and then forming a moisture-preventing protective layer/a light reflecting layer on the surface of the phosphor, is associated with following drawbacks:

- 5 Drawback (A): A polyparaxylilene film cannot provide a sufficient moisture barrier property to alkali halide such CsI:Tl, and CsI shows deliquescence in a prolonged storage.

Such drawback (A) occurs similarly also in a
10 digital X-ray image pickup apparatus formed with the aforementioned method (2) by adhering a panel of phosphor with an adhesive material, either directly or across a protective layer, on the surface of the photoelectric converting device and then forming a
15 moisture-preventing protective layer of paraxylilene at least on a surface of the phosphor of the phosphor panel.

In order to solve the drawback (A), it is conceivable, for increasing the moisture preventing
20 effect of the conventionally known moisture-preventing protective layer, to increase a thickness of paraxylilene film. However, an increase in the thickness of the moisture-preventing protective layer results in a new drawback of a proportional loss in a
25 resolution (CTF) of the X-ray pickup image.

Drawback (B): In case of forming a polyparaxylilene film as a moisture preventing film

by thermal CVD on a surface of a phosphor composed of an alkali halide such as CsI:Tl and a light emission activator, there cannot be obtained a sufficient adhesion between a surface of the phosphor constituted of alkali halide and the polyparaxylilene film. On the other hand, in case a moisture-preventing protective layer constituted of a thin metal film is formed on the surface of the polyparaxylilene moisture-preventing film for further improving the moisture preventing effect, an interlayer cleavage occurs at an interface between paraxylilene and alkali halide phosphor because of a stress in the metal film. In a part with a defective adhesion, the function of the moisture-preventing protective layer is deteriorated thereby facilitating the deliquescence of the alkali halide phosphor.

SUMMARY OF THE INVENTION

The present invention has been made on the above-described consideration.

An object of the present invention is to provide a moisture-preventing protective layer showing satisfactory adhesion with a phosphor constituted of an alkali halide and a light emission activator.

The present invention has been made on the above-described consideration.

An object of the present invention is to provide a moisture-preventing protective layer showing satisfactory adhesion with a phosphor constituted of an alkali halide and a light emission
5 activator.

A radiation converting substrate of the present invention, constituted by forming a phosphor layer for converting a radiation into light and a moisture-preventing protective layer covering the phosphor
10 layer in succession on a substrate capable of transmitting the radiation, is featured in that the aforementioned moisture-preventing protective layer is constituted of a first plasma polymerization film formed from a monomer of a silane compound, and a
15 second plasma polymerization film formed from a monomer of a fluorine-containing unsaturated hydrocarbon.

A radiation image pickup apparatus of the present invention, constituted by forming a phosphor
20 layer for converting a radiation into light and a moisture-preventing protective layer covering the phosphor layer in succession, either directly or across a protective layer, on a sensor substrate provided with a photoelectric converting element, is
25 featured in that the aforementioned moisture-preventing protective layer is constituted of a first plasma polymerization film formed from a monomer of a

silane compound, and a second plasma polymerization film formed from a monomer of a fluorine-containing unsaturated hydrocarbon.

Also the radiation image pickup apparatus of
5 the present invention is formed by adhering a radiation converting substrate of the present invention and a sensor substrate provided with a photoelectric converting element.

A radiation image pickup system of the present
10 invention utilizes the radiation image pickup apparatus of the present invention. In the present specification, in addition to X-ray, electromagnetic waves such as α -ray, β -ray, γ -ray etc. are also included in the radiation.

15 Other features and advantages of the present invention will be apparent from the following description taken in conjunction with the accompanying drawings, in which like reference characters designate the same or similar parts
20 throughout the figures thereof.

BRIEF DESCRIPTION OF THE DRAWINGS

Fig. 1 is a schematic cross-sectional view of a radiation image pickup apparatus formed by adhering a
25 phosphor panel (radiation converting substrate) and a sensor panel (sensor substrate) and constituting a first embodiment of the present invention;

Fig. 2 is a schematic cross-sectional view of a radiation image pickup apparatus constituting a second embodiment of the present invention; and

Fig. 3 is a conceptual view showing the configuration of a radiation image pickup system of the present invention.

DESCRIPTION OF THE PREFERRED EMBODIMENTS

In the following, embodiments of the present invention will be explained in detail, with reference to accompanying drawings.

Fig. 1 is a schematic cross-sectional view of a radiation image pickup apparatus formed by adhering a phosphor panel (radiation converting substrate) and a sensor panel (sensor substrate) and constituting a first embodiment of the present invention. On a substrate 11 capable of transmitting X-ray, there is formed a phosphor layer 12 constituted of an alkali halide and a light emission activator. A phosphor panel is constituted by forming a plasma polymerization film 13 of a silane compound and a plasma polymerization film 14 formed from a fluorine-containing unsaturated hydrocarbon monomer in succession so as to cover the surface of the phosphor layer 12. This phosphor panel is adhered, with an adhesive material 15, to a sensor substrate 17 on which a photoelectric converting element 16 to

constitute the radiation image pickup apparatus. For the sensor substrate (sensor panel), there can be employed, for example, a sensor substrate bearing a photoelectric converting element and a TFT utilizing
5 amorphous silicon on an insulating substrate such as of glass, as disclosed in Japanese Patent No. 3066944.

The plasma polymerization film 14 formed from a fluorine-containing unsaturated hydrocarbon monomer preferably has a water vapor permeation rate of 10^{-11}
10 (g·cm/cm²·cmHg·sec) or less.

The fluorine-containing unsaturated hydrocarbon monomer can be, for example, C₂F₃H, C₂F₂H₂, C₂F₃Cl, C₂F₂Cl₂, CF₃CFCFCF₃, CF₂CFCFCF₂, or CF₃CCCF₃. In particular, a fluorine-containing unsaturated
15 hydrocarbon monomer containing hydrogen and fluorine such as C₂F₃H or C₂F₂H₂ can further reduce the water vapor permeation rate.

For obtaining a plasma polymerization film 13 with satisfactory adhesion with the phosphor, there
20 can be employed, as a monomer gas, a silane compound such as tetramethoxysilane, dimethyldimethoxysilane, hexamethyldisiloxane or vinyltrimethoxysilane. It is found that, in particular, dimethyldimethoxysilane has an adequate adhesive force both to a phosphor
25 formed by the alkali halide and to a moisture-preventing plasma polymerization film composed of the fluorine-containing unsaturated hydrocarbon. This is

presumably because of a fact that a methoxy group of dimethyldimethoxysilane is reactive with an inorganic substance (phosphor) and a methyl group has a high reactivity with an organic substance (moisture-
5 preventing protective layer).

At the surface of the phosphor, a plasma polymerization was conducted by introducing a monomer of a silane compound into a reaction system, thereby forming a first plasma polymerization film 13 of a
10 thickness of 100 to 1000 Angstroms, having an adhesion assisting function. Then a fluorine-containing unsaturated hydrocarbon monomer was introduced into the reaction system to form a second plasma polymerization film 14 as a moisture-
15 preventing protective layer, so as to cover the first plasma polymerization film 13. An interface of the first plasma polymerization film 13 and the second plasma polymerization film 14 constitutes a layer in which both substances are mixed.

20 The plasma polymerization film is a film formed by the organic monomer, which is excited in a low-temperature plasma and is polymerized into a polymer on the surface of the alkali halide phosphor.

For the phosphor, an alkali halide:activator
25 system can be advantageously employed, and, in addition to CsI:Tl, there can also be employed CsI:Na, NaI:Tl, LiI:Eu, KI:Tl etc.

Fig. 2 is a schematic cross-sectional view of a radiation image pickup apparatus of a second embodiment of the present invention. As shown in Fig. 2, the radiation image pickup apparatus of this embodiment is constituted by forming a phosphor layer 23 on a sensor substrate (sensor panel) 21 provided with a photoelectric converting element 22, and further forming thereon a first plasma polymerization film 24 and second plasma polymerization film 25 in succession so as to cover the phosphor layer 23. Materials and producing methods for the sensor substrate (sensor panel), the phosphor layer, the first plasma polymerization film and the second plasma polymerization film are similar to those in the first embodiment.

Also a protective layer may be provided between the sensor substrate and the phosphor layer, in order to prevent an erosion of the photoelectric converting image pickup element by the phosphor layer formed by alkali halide and also to prevent a peeling of the phosphor layer by an incomplete adhesion thereof, and such protective layer can be formed, for example, by SiN, TiO₂, LiF, Al₂O₃, MgO etc., or by polyphenylene sulfide resin, fluorinated resin, polyether ether ketone resin, liquid crystal polymer, polyethernitrile resin, polysulfone resin, polyethersulfone resin, polyallylate resin,

polyamidimide resin, polyetherimide resin, polyimide resin, epoxy resin, or silicone resin. There is preferred a resin capable of standing an evaporation temperature at the formation of the phosphor, and a
5 thermal diffusion temperature of the light emission activator. There is also preferred a heat resistance with a thermal deformation temperature of 180°C or higher.

In the following, there will be explained
10 examples of the present invention.

(Example 1)

On a surface of an amorphous carbon substrate of a thickness of 1 mm, an alkali halide phosphor layer of CsI:Tl was formed by evaporation with a
15 thickness of 450 μ m, and was heat treated for 2 hours at 250°C to activate the light emission activator Tl. Then the substrate, bearing the formed phosphor, was set on an electrode of a plasma polymerization apparatus including parallel plate-shaped electrodes,
20 and was maintained in a vacuum state. Thereafter, a first plasma polymerization film and a second plasma polymerization film were formed under following conditions.

(First plasma polymerization film)

25 Pressure in the polymerization apparatus: 80 Pa
(0.6 Torr)

Monomer gas: dimethyldimethoxysilane

Monomer gas flow rate: 20 SCCM

Power of high frequency power source: 50 W

Discharge time: 5 minutes

(Second plasma polymerization film)

5 Pressure in the polymerization apparatus: 13.3 Pa
(0.1 Torr)

Monomer gas: C_2F_3H

Monomer gas flow rate: 50 SCCM

Power of high frequency power source: 50 W

10 Discharge time: 20 minutes

Such formation of the first plasma
polymerization film and the second plasma
polymerization film provided a moisture-preventing
film of a moisture permeation rate of 1.9×10^{-12}
15 (g·cm/cm²·cmHg·sec), thereby completing a phosphor
panel. The moisture-preventing protective layer had
a thickness of 5000 Angstroms (0.5 μ m).

This phosphor panel did not show deliquescence
of CsI:Tl even after a standing for 100 hours in an
20 atmosphere of a temperature of 40°C and a humidity of
90%. Also, since the moisture-preventing protective
layer was as thin as 0.5 μ m, there was not observed a
deterioration of CTF, resulting from the moisture-
preventing protective layer. A conventional
25 moisture-preventing protective film of paraxylilene
required a thickness of 2 to 4 μ m for achieving a
moisture-preventing function of a level similar to

that of the protective film of this example, and showed a deterioration in CTF.

In a conventional example with a moisture-preventing protective layer of a thickness of 2 to 4
5 μm , a deterioration of CTF (image resolution) was observed in an initial stage.

Also a moisture-preventing protective layer of paraxylilene with a thickness of 0.5 μm showed a deterioration of CTF, in a condition of a standing
10 for 100 hours in an atmosphere of a temperature of 40°C and a humidity of 90%.

(Example 2)

On a surface of a photoelectric converting element of a sensor panel, prepared by forming the
15 photoelectric converting element on a glass substrate, there was evaporated, across a polyimide protective layer (thickness 5 μm), a pillar-shaped phosphor (pillar diameter: 6 - 10 μm) composed of CsI:Tl was evaporated with a thickness of 500 μm , and a first
20 plasma polymerization film and a second plasma polymerization film same as in Example 1 were formed with a thickness of 5000 Angstroms. Then a reflective layer of aluminum was formed to complete an X-ray image pickup apparatus.

25 The X-ray image pickup apparatus did not show deliquescence of CsI:Tl after a standing as in Example 1 for 100 hours in an atmosphere of a

temperature of 40°C and a humidity of 90%.

(Example 3)

A moisture-preventing protective film of a similar effect could be obtained also by changing the monomer gas for the second plasma polymerization film in Example 1 to $\text{CF}_2\text{CFCFCF}_2$. A first plasma polymerization film and a second plasma polymerization film were prepared under following conditions.

10 (First plasma polymerization film)

Pressure in the polymerization apparatus: 80 Pa
(0.6 Torr)

Monomer gas: dimethyldimethoxysilane

Monomer gas flow rate: 20 SCCM

15 Power of high frequency power source: 50 W

Discharge time: 5 minutes

(Second plasma polymerization film)

Pressure in the polymerization apparatus: 13.3 Pa
(0.1 Torr)

20 Monomer gas: $\text{CF}_2\text{CFCFCF}_2$

Monomer gas flow rate: 50 SCCM

Power of high frequency power source: 50 W

Discharge time: 10 minutes

The second plasma polymerization film had a thickness of 8000 Angstroms.

(Example 4)

A first plasma polymerization film and a second

plasma polymerization film were prepared under following conditions.

(First plasma polymerization film)

Pressure in the polymerization apparatus: 80 Pa

5 (0.6 Torr)

Monomer gas: tetramethoxysilane

Monomer gas flow rate: 20 SCCM

Power of high frequency power source: 50 W

Discharge time: 5 minutes

10 (Second plasma polymerization film)

Pressure in the polymerization apparatus: 13.3 Pa

(0.1 Torr)

Monomer gas: C_2F_3H

Monomer gas flow rate: 50 SCCM

15 Power of high frequency power source: 50 W

Discharge time: 20 minutes

Also in this example, there was obtained a moisture-preventing protective layer having an effect similar to that in Example 1.

20 (Example 5)

A first plasma polymerization film and a second plasma polymerization film were prepared under following conditions.

(First plasma polymerization film)

25 Pressure in the polymerization apparatus: 80 Pa

(0.6 Torr)

Monomer gas: dimethyldimethoxysilane

Monomer gas flow rate: 20 SCCM

Power of high frequency power source: 50 W

Discharge time: 5 minutes

(Second plasma polymerization film)

5 Pressure in the polymerization apparatus: 13.3 Pa
(0.1 Torr)

Monomer gas: CF_3CCCF_3

Monomer gas flow rate: 50 SCCM

Power of high frequency power source: 50 W

10 Discharge time: 8 minutes

The second plasma polymerization film had a thickness of about 8000 Angstroms.

Also in this example, there was obtained a moisture-preventing protective layer having an effect
15 similar to that in Example 1.

In the following, there will be explained an application of the foregoing examples to a radiation (X-ray) image pickup apparatus.

Fig. 3 shows an example of application of the
20 radiation image pickup apparatus of the present invention to an X-ray diagnostic system.

An X-ray 6060, generated from an X-ray bulb 6050, is transmitted by a chest part 6062 of a patient or an inspection subject 6061, and enters a
25 radiation image pickup apparatus (image sensor) 6040 as shown in Fig. 1 or 2. The incident X-ray contains information of the interior of the body of the

patient 6061. In response to the entry of X-ray, a
scintillator (phosphor layer) emits light, which is
subjected to a photoelectric conversion by a
photoelectric converting element of the sensor panel
5 to obtain electrical information. Such information
is converted into a digital form, then subjected to
an image processing by an image processor 6070
constituting signal processing means, and can be
observed on a display 6080 constituting display means
10 in a control room.

Also, this information can be transmitted to a
remote location by transmission means such as a
telephone line 6090 and can be displayed on a display
6081 constituting display means for example in a
15 doctor room in another location or stored in
recording means such as an optical disk, thereby also
enabling a diagnosis by a doctor in a distant
location. It may also be recorded on a film 6110 by
a film processor 6100 constituting recording means.

20 As explained in the foregoing, the present
invention is applicable to an X-ray sensor for
medical use, but is also effective in other
applications such as a non-destructive testing.

As explained in the foregoing, a moisture-
25 preventing protective film constituted of the plasma
polymerization film of the present invention has a
superior adhesion to a phosphor, for example composed

of alkali halide, in comparison with the already known moisture-preventing protective film of paraxylilene.

Also in a radiation image pickup apparatus
5 constituted by forming a moisture-preventing protective layer on a sensor substrate bearing a photoelectric converting element and a phosphor layer, it was possible to prevent an interlayer cleavage between the phosphor layer and the moisture-
10 preventing protective layer resulting from a difference in thermal expansion of the sensor substrate and the phosphor layer in a storage environment.

As many apparently widely different embodiments
15 of the present invention can be made without departing from the spirit and scope thereof, it is to be understood that the invention is not limited to the specific embodiments thereof except as defined in the claims.